

116-93-428-41-007000

116-93-428-41-007000 Information

Container.com	 116-93-428-41-007000 Mill-Max Manufacturing Corp. Connectors, Interconnects Sockets for ICs, Transistors CONN IC DIP SOCKET 28POS GOLD - For the pricing/inventory/lead time, please contact	
For Reference Only	us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



116-93-428-41-007000 Specifications

ManufacturerMill-Max Manufacturing Corp.CategoryConnectors, InterconnectsSockets for ICs, TransistorsPackage-Series116TypeDIP, 0.4" (10.16mm) Row SpacingNumber of Positions or Pins (Grid)28 (2 x 14)Pitch - MatingOl00" (2.54mm)Contact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Contact Finish Thickness - MatingBeryllium CopperMounting TypeThrough HoleFeaturesElevated, Open FramePerturesSolderContact Finish - Post0.100" (2.54mm)Contact Finish PostSolderContact Finish PostSolderContact Finish PostSolderContact Finish PostSolderContact Finish Thickness - Post20µin (0.50µm)Contact Finish Thickness - Post20µin (0.50µm)Contact Finish Thickness - Post20µin (5.08µm)Contact Material - PostFras AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), Polyester			
CategoryConnectors, InterconnectsCategoryConnectors, InterconnectsPackage-Series116TypeDIP, 0.4" (10.16mm) Row SpacingNumber of Positions or Pins (Grid)28 (2 x 14)Pitch - Mating0.100" (2.54mm)Contact Finish - MatingGoldContact Finish - Mating30µin (0.76µm)Contact Finish Thickness - MatingBeryllium CopperContact Material - MatingBeryllium CopperFeaturesElevated, Open FrameFeaturesSolderPitch - Post0.100" (2.54mm)Contact Finish Thickness - Post200µin (5.08µm)Contact Finish Thickness - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialFras AlloyContact Material - PostSockerContact Finish Thickness - PostSockerContact Finish Thickness - PostSockerContact Material - PostSrass AlloyContact Material - PostSockerContact Material - PostSockerContact Finish Thickness - PostSockerContact Finish Thickness - PostSockerContact Material - PostSocker<	Manufacturer Part Number	116-93-428-41-007000	
Sockets for ICs, TransistorsPackage-Series116TypeDIP, 0.4" (10.16mm) Row SpacingNumber of Positions or Pins (Grid)28 (2 x 14)Pitch - Mating0.100" (2.54mm)Contact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Contact Funish Thickness - MatingBeryllium CopperMounting TypeThrough HoleFeaturesElevated, Open FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish Thickness - Post200µin (5.08µm)Contact Finish Thickness - Post200µin (5.08µm)Contact Finish Thickness - PostPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Manufacturer	Mill-Max Manufacturing Corp.	
Package-Series116TypeDIP, 0.4" (10.16mm) Row SpacingNumber of Positions or Pins (Grid)28 (2 x 14)Pitch - Mating0.100" (2.54mm)Contact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Contact Material - MatingBeryllium CopperMounting TypeThrough HoleFeaturesElevated, Open FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish Thickness - Post200µin (5.08µm)Contact Finish Thickness - Post200µin (5.08µm)Contact Finish Thickness - PostBrass AlloyContact Material - PostPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Category	Connectors, Interconnects	
Number116TypeDIP, 0.4" (10.16mm) Row SpacingNumber of Positions or Pins (Grid)28 (2 x 14)Pitch - Mating0.100" (2.54mm)Contact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Contact Material - MatingBeryllium CopperMounting TypeThrough HoleFeaturesElevated, Open FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish Thickness - Post0.100" (2.54mm)Contact Finish - Post0.100" (2.54mm)Contact Finish - Post0.100" (2.54mm)Contact Finish Thickness - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C		Sockets for ICs, Transistors	
Type DIP, 0.4" (10.16mm) Row Spacing Number of Positions or Pins (Grid) 28 (2 x 14) Pitch - Mating 0.100" (2.54mm) Contact Finish - Mating Gold Contact Finish Thickness - Mating 30µin (0.76µm) Contact Material - Mating Beryllium Copper Mounting Type Through Hole Features Elevated, Open Frame Termination Solder Pitch - Post 0.100" (2.54mm) Contact Finish Thickness - Post 200µin (5.08µm) Contact Finish Thickness - Post 200µin (5.08µm) Contact Material - Post Brass Alloy Polycyclohexylenedimethylene Terephthalate (PCT), Polyester Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	Package	-	
Number of Positions or Pins (Grid)28 (2 x 14)Pitch - Mating0.100" (2.54mm)Contact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Contact Material - MatingBeryllium CopperMounting TypeThrough HoleFeaturesElevated, Open FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish Thickness - Nost200µin (5.08µm)Contact Finish Thickness - Post200µin (5.08µm)Contact Finish Thickness - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Series	116	
Pitch - Mating0.100" (2.54mm)Contact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Contact Material - MatingBeryllium CopperMounting TypeThrough HoleFeaturesElevated, Open FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostDino" (2.54mm)Contact Finish - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Туре	DIP, 0.4" (10.16mm) Row Spacing	
Contact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Contact Material - MatingBeryllium CopperMounting TypeThrough HoleFeaturesElevated, Open FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostTin-LeadContact Finish Thickness - Post20µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Number of Positions or Pins (Grid)	28 (2 x 14)	
Contact Finish Thickness - Mating30µin (0.76µm)Contact Material - MatingBeryllium CopperMounting TypeThrough HoleFeaturesElevated, Open FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostTin-LeadContact Finish Thickness - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Pitch - Mating	0.100" (2.54mm)	
Contact Material - MatingBeryllium CopperMounting TypeThrough HoleFeaturesElevated, Open FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostTin-LeadContact Finish Thickness - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Contact Finish - Mating	Gold	
Mounting TypeThrough HoleFeaturesElevated, Open FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostTin-LeadContact Finish Thickness - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Contact Finish Thickness - Mating	30µin (0.76µm)	
FeaturesElevated, Open FrameTerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostTin-LeadContact Finish Thickness - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Contact Material - Mating	Beryllium Copper	
TerminationSolderPitch - Post0.100" (2.54mm)Contact Finish - PostTin-LeadContact Finish Thickness - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Mounting Type	Through Hole	
Pitch - Post0.100" (2.54mm)Contact Finish - PostTin-LeadContact Finish Thickness - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Features	Elevated, Open Frame	
Contact Finish - PostTin-LeadContact Finish Thickness - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Termination	Solder	
Contact Finish Thickness - Post200µin (5.08µm)Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Pitch - Post	0.100" (2.54mm)	
Contact Material - PostBrass AlloyHousing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Contact Finish - Post	Tin-Lead	
Housing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Contact Finish Thickness - Post	200µin (5.08µm)	
Operating Temperature $-55^{\circ}C \sim 125^{\circ}C$	Contact Material - Post	Brass Alloy	
	Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	
Report errors?	Operating Temperature	-55°C ~ 125°C	
			Report errors?

116-93-428-41-007000 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

116-93-428-41-007000 Payment Methods





If you have any question about 116-93-428-41-007000, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com